



FETek Technology Corp.

FKR0004

N-Ch 100V Fast Switching MOSFETs



- ★ Super Low Gate Charge
- ★ Green Device Available
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary

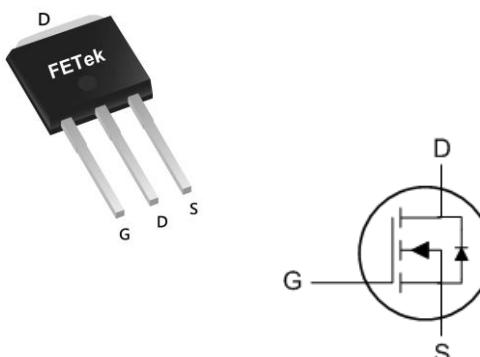
BVDSS	RDS(on)	ID
100V	112mΩ	12A

Description

The FKR0004 is the high cell density trenched N-ch MOSFETs, which provide excellent RDS(on) and gate charge for most of the synchronous buck converter applications.

The FKR0004 meet the RoHS and Green Product requirement with full function reliability approved.

TO251 Pin Configuration

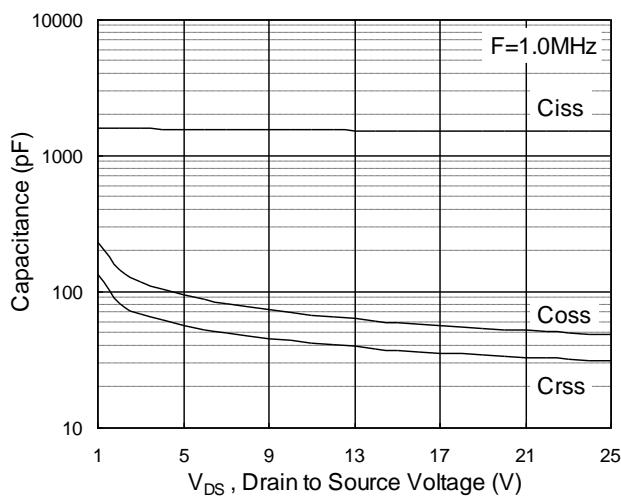
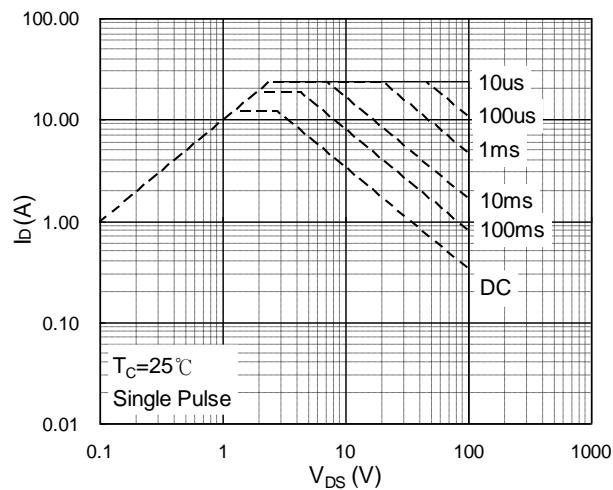
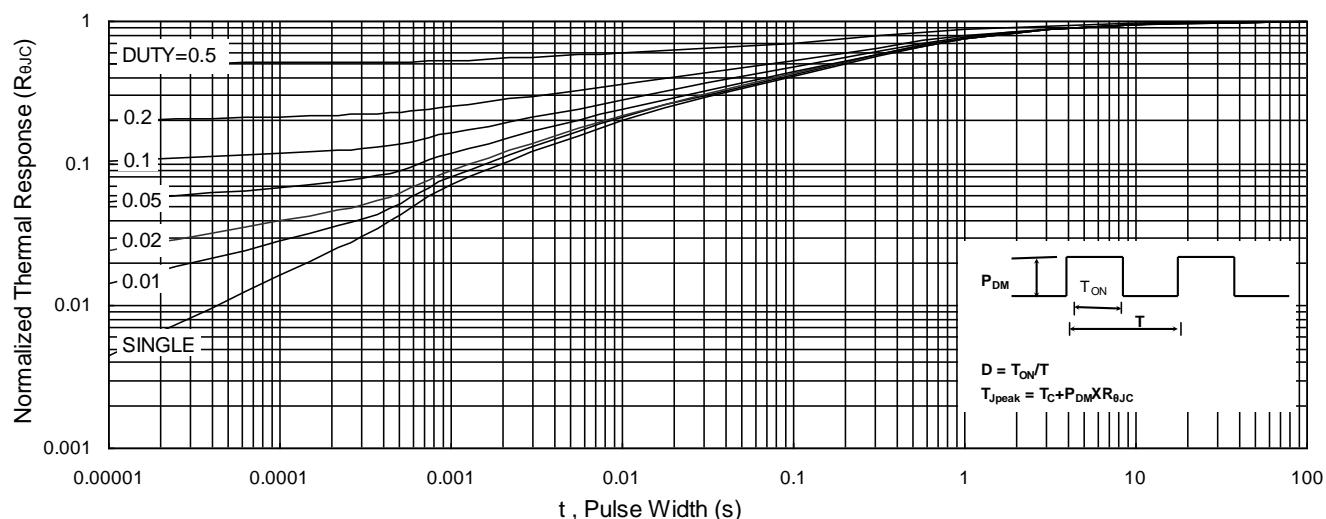
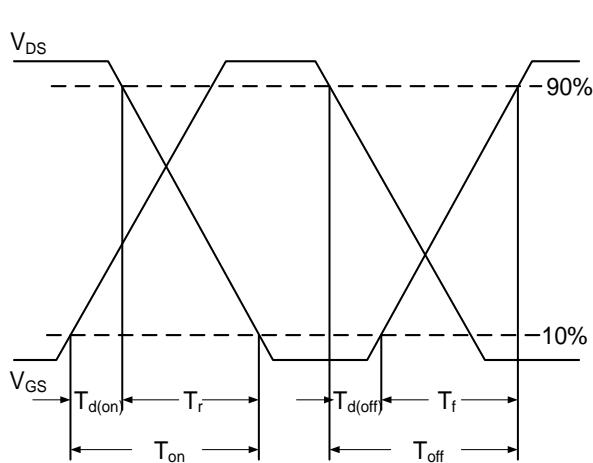
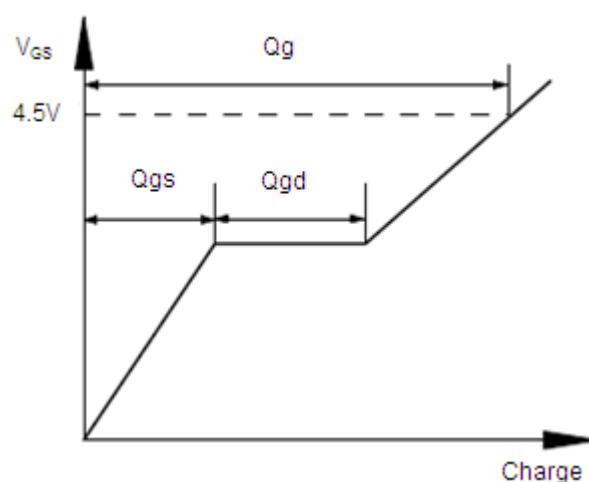


Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	100	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	12	A
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	7.7	A
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	3	A
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	2.4	A
I _{DM}	Pulsed Drain Current ²	24	A
P _D @T _C =25°C	Total Power Dissipation ³	34.7	W
P _D @T _A =25°C	Total Power Dissipation ³	2	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-ambient ¹	---	62	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹	---	3.6	°C/W


Fig.7 Capacitance

Fig.8 Safe Operating Area

Fig.9 Normalized Maximum Transient Thermal Impedance

Fig.10 Switching Time Waveform

Fig.11 Gate Charge Waveform